

STW45NM60

N-channel 650V@Tjmax - 0.09Ω - 45A - TO-247 MDmesh™ Power MOSFET

Features

Туре	V _{DSS} (@Tjmax) R _{DS(on)}		I _D
STW45NM60	650V	< 0.11Ω	45A

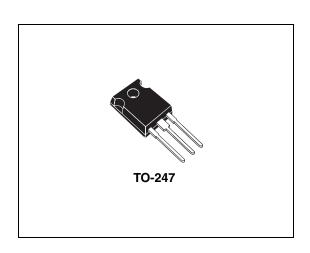
- High dv/dt and avalanche capabilities
- 100% avalanche tested
- Low input capacitance and gate charge
- Low gate input resistance

Description

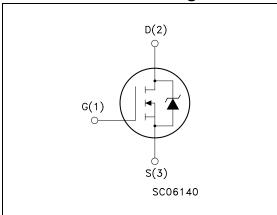
The MDmesh™ is a new revolutionary Power MOSFET technology that associates the multiple drain process with the Company's PowerMESH™ horizontal layout. The resulting product has an outstanding low on-resistance, impressively high dv/dt and excellent avalanche characteristics. The adoption of the Company's proprietary strip technique yields overall dynamic performance that is significantly better than that of similar competitor's products.

Application

■ Switching application



Internal schematic diagram



Order code

Part number	Marking	Package	Packaging	
STW45NM60	W45NM60	TO-247	Tube	

April 2007 Rev 8 1/12

Contents STW45NM60

Contents

1	Electrical ratings	3
2	Electrical characteristics	4
	2.1 Electrical characteristics (curves)	6
3	Test circuit	8
4	Package mechanical data	9
5	Revision history 1	11

STW45NM60 Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{GS}	Gate- source voltage	±30	V
I _D	Drain current (continuous) at T _C = 25°C	45	Α
I _D	Drain current (continuous) at T _C = 100°C	28	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	180	Α
P _{TOT}	Total dissipation at T _C = 25°C	417	W
	Derating factor	3.33	W/°C
dv/dt (2)	Peak diode recovery voltage slope	15	V/ns
T _{stg}	Storage temperature	-65 to 150	°C
Tj	Max. operating junction temperature	150	°C

^{1.} Pulse width limited by safe operating area

Table 2. Thermal data

Symbol	Parameter	Value	Unit
Rthj-case	Thermal resistance junction-case	0.3	°C/W
Rthj-amb	Thermal resistance junction-amb	30	°C/W
T _I	Maximum lead temperature for soldering purpose	300	°C

Table 3. Avalanche characteristics

Symbol	Parameter	Max value	Unit
I _{AR}	Avalanche current, repetitive or not-repetitive (pulse width limited by T _j max)	15	Α
E _{AS}	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 35$ V)	850	mJ

^{2.} $I_{SD} \le 45A$, $di/dt \le 400A/\mu s$, $V_{DD} \le 80\%$ $V_{(BR)DSS}$

Electrical characteristics STW45NM60

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250 \mu\text{A}, V_{GS} = 0$	600			٧
	Zero gate voltage	V _{DS} = Max rating			10	μΑ
I _{DSS}	Drain current (V _{GS} = 0)	V _{DS} = Max rating, T _C = 125 °C			100	μΑ
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	$V_{GS} = \pm 30V$			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10V, I _D = 22.5A		0.09	0.11	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 _{fs} ⁽¹⁾	Forward transconductance	$V_{DS} > I_{D(on)} \times R_{DS(on)max},$ $I_{D} = 22.5A$		30		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 25V$, f = 1 MHz, $V_{GS} = 0$		3800 1250 80		pF pF pF
C _{oss eq.} ⁽²⁾	Equivalent output capacitance	V _{GS} = 0V, V _{DS} = 0V to 480V		340		pF
R _G	Gate input resistance	f=1 MHz Gate DC Bias = 0 test signal level = 20mV open drain		1.4		Ω
Q_g	Total gate charge	$V_{DD} = 400V, I_D = 45A,$		96	134	nC
Q _{gs} Q _{gd}	Gate-source charge Gate-drain charge	V _{GS} = 10V Figure 14		31 43		nC nC

^{1.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%.

^{2.} $C_{\rm oss~eq.}$ is defined as a constant equivalent capacitance giving the same charging time as $C_{\rm oss}$ when $V_{\rm DS}$ increases from 0 to 80% $V_{\rm DSS}$

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time Rise time	$V_{DD} = 250V, I_{D} = 22.5A$ $R_{G} = 4.7\Omega V_{GS} = 10V$ Figure 13		30 20		ns ns
t _{r(Voff)} t _f t _C	Off-voltage rise time Fall time Cross-over time	$V_{DD} = 400V$, $I_D = 45A$, $R_G = 4.7\Omega$, $V_{GS} = 10V$ Figure 13		16 23 40		ns ns ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current				45	Α
I _{SDM}	Source-drain current (pulsed)				180	Α
V _{SD} ⁽¹⁾	Forward on voltage	$I_{SD} = 45A, V_{GS} = 0$			1.5	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 45A,$ $di/dt = 100A/\mu s,$ $V_{DD} = 100 \text{ V}, T_j = 25^{\circ}\text{C}$ Figure 15		508 10 40		ns μC Α
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 45A$, $di/dt = 100A/\mu s$, $V_{DD} = 100 \text{ V}$, $T_j = 150^{\circ}\text{C}$ Figure 15		650 14 43		ns μC A

^{1.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%.

Electrical characteristics STW45NM60

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

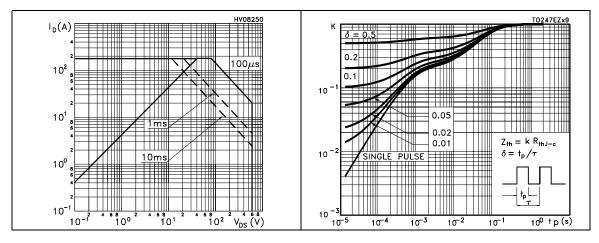


Figure 3. Output characteristics

Figure 4. Transfer characteristics

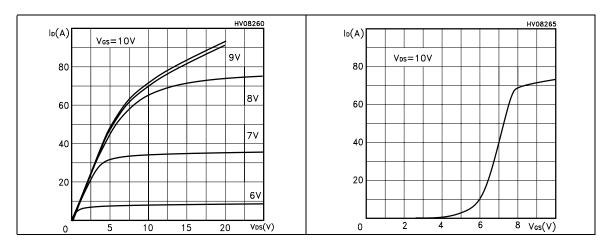


Figure 5. Transconductance

Figure 6. Static-drain source on resistance

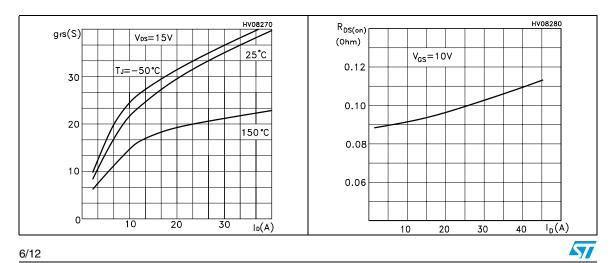


Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variations

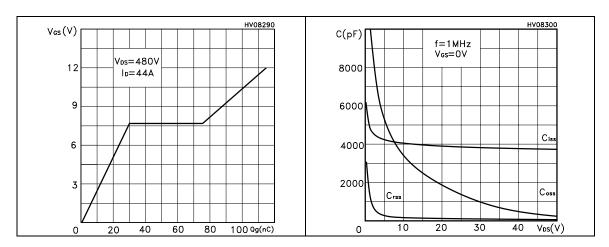


Figure 9. Normalized gate threshold voltage Figure 10. Normalized on resistance vs vs temperature temperature

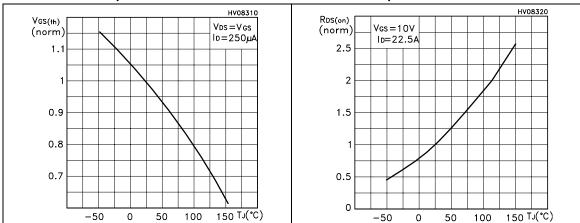
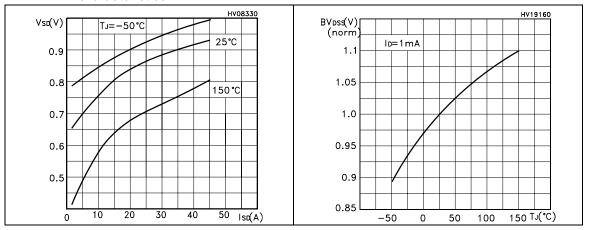


Figure 11. Source-drain diode forward characteristics

Figure 12. Normalized $\mathrm{BV}_{\mathrm{DSS}}$ vs temperature



Test circuit STW45NM60

3 Test circuit

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

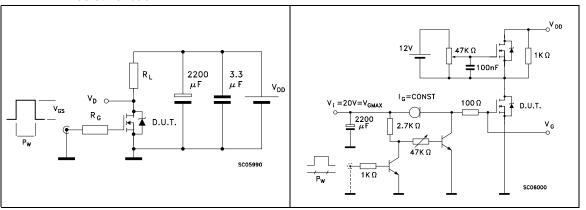


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped inductive load test circuit

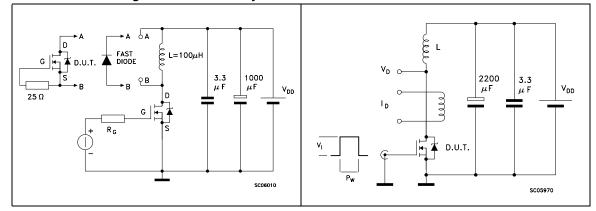
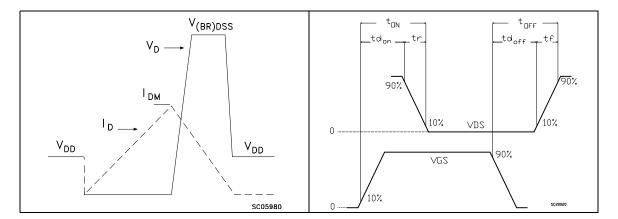


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



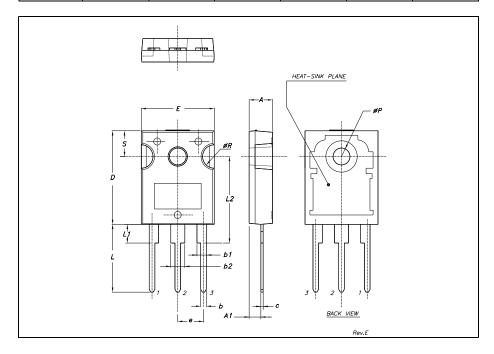
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

577

TO-247 MECHANICAL DATA

DIM.		mm.		incl		
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	4.85		5.15	0.19		0.20
A1	2.20		2.60	0.086		0.102
b	1.0		1.40	0.039		0.055
b1	2.0		2.40	0.079		0.094
b2	3.0		3.40	0.118		0.134
С	0.40		0.80	0.015		0.03
D	19.85		20.15	0.781		0.793
E	15.45		15.75	0.608		0.620
е		5.45			0.214	
L	14.20		14.80	0.560		0.582
L1	3.70		4.30	0.14		0.17
L2		18.50			0.728	
øΡ	3.55		3.65	0.140		0.143
øR	4.50		5.50	0.177		0.216
S		5.50			0.216	



STW45NM60 Revision history

5 Revision history

Table 8. Revision history

Date	Revision	Changes
05-Mar-2005	5	Complete document with curves
16-May-2006	6	The document has been reformatted
18-Dec-2006	7	Updates curves: Figure 1., Figure 4. and Figure 6.
02-Apr-2007	8	Figure 1. has been updated.

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577